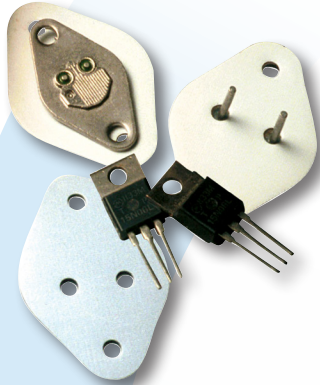




HIGH PERFORMANCE THERMAL INTERFACE PRODUCTS

The Tgard™ 200 is a high performance interface pad. Consisting of a silicone/boron nitride composite, these fiberglass-reinforced pads are used when the lowest thermal resistance and highest dielectric strength are required

A high-tear, cut-through and puncture-resistant product, the Tgard™ 200 is tough and strong. Burrs cause no problems for the material and the pad will not dry out, crack or fail when pressured between mating parts.

The Tgard™ 200 is available in the following sizes:

0.010" (0.25 mm) die cut shapes only

0.020" (0.51 mm) sheets and die cut shapes

0.030" (0.75 mm) sheets and die cut shapes

FEATURES AND BENEFITS

- High thermal Conductivity of 5.0 W/mK
- High breakdown voltage of > 6,000 volts
- Resistant to tears and punctures
- UL® 94 V0 rated

APPLICATIONS

- Audio and video components
- Automotive control units
- General high pressure interfaces
- Motor controllers
- Power conversion equipment
- Power semiconductors
 - TO packages, MOSFETs and IGBTs

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TgardTM 200 Series

Thermally Conductive Insulators

	TGARD TM 210	TGARD TM 220	TGARD TM 230	TEST METHOD
Construction & Composition	Reinforced boron nitride filled silicone elastomer	Reinforced boron nitride filled silicone elastomer	Reinforced boron nitride filled silicone elastomer	
Color	White	Blue	Green	Visual
Thickness	0.010" (0.25mm)	0.020" (0.51mm)	0.030" (0.76mm)	
Thickness tolerance	±0.002" (±0.05mm)	±0.002" (±0.05mm)	±0.003" (±0.075mm)	
Specific Gravity (Density)	1.52 g/cc	1.45 g/cc	1.47 g/cc	Helium Pycnometer
Hardness	85 Shore A	80 Shore A	80 Shore A	ASTM D2240
Tensile Strength	N/A	N/A	N/A	ASTM D412
% Elongation	N/A	N/A	N/A	ASTM D412
Outgassing TML (Post Cured)	0.06%	0.06%	0.06%	ASTM E595
Outgassing CVCN (Post Cured)	0.05%	0.05%	0.05%	ASTM E595
UL Flammability Rating	94 V0	94 V1	Not Rated	E180840
Temperature Range	-60°C to 200°C	-60°C to 200°C	-60°C to 200°C	
Thermal Conductivity	5 W/mK	5 W/mK	5 W/mK	ASTM D5470 (modified)
Thermal Impedance @ 100 psi @ 689 KPa	0.18°C-in ² /W 1.17°C-cm ² /W	0.35°C-in ² /W 2.26°C-cm ² /W	0.40°C-in ² /W 2.28°C-cm ² /W	ASTM D5470 (modified)
Breakdown Voltage	6,000 VAC	10,000 VAC	20,000 VAC	ASTM D149
Volume Resistivity	5x10 ¹³ ohm-cm	5x10 ¹³ ohm-cm	5x10 ¹³ ohm-cm	ASTM D257
Dielectric Constant @ 1 MHz	3.32	3.32	3.32	ASTM D150

Standard thicknesses: 0.010" (0.25 mm) die cut shapes only, 0.020" (0.51 mm), 0.030" (0.76 mm)

Standard sheet sizes: 0.020" and 0.030": 16" x 16" (406 mm x 406 mm) Individual die-cut shapes can be supplied.

Pressure sensitive adhesive: Request no adhesive with "AO" suffix. Request adhesive on one side with "A1" suffix. Double-sided adhesive is not available.

Reinforcement: TgardTM 200 sheets are fiberglass reinforced.

Data for design engineer guidance only. Observed performance varies in application. Engineers are reminded to test the material in application.

THR-DS-Tgard-200 0313

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